Self-organized Nanodot Formation on InP(100) by Argon Ion Sputtering

Tan Sian Khong* and Andrew Wee Thye Shen[†] Department of Physics, National University of Singapore

I. Introduction

In recent years, the formation of nanostructures on semiconductor surfaces has attracted much interest due to their potential for applications in low-dimensional devices, particularly as ordered quantum nanodots for optoelectronics and guantum devices.

Low energy ion sputtering using inert gases such as argon has been shown to be a promising non-lithographic, and hence simpler technique for the formation of surface nanostructures.

Low energy argon ion sputtering has been used to form highly ordered self-assembling nanodots on GaSb,¹ InP² and Si(100)³ surfaces.

II. Objective

Formation of self-organized ordered nanodots array on InP(100) surface by rastered Ar⁺ beam sputtering at normal incidence.

Δr

InP(100)

III. Experiment



- with EXO5 sputtering gun under the following conditions:
 - Ion Beam : 1 keV Ar+

Substrate : InP(100)

- Incidence angle : Normal
- * Raster Size : 2.57 × 3.35 mm²
- Stage temperature, T = -110 °C, 23 °C and 36 °C.

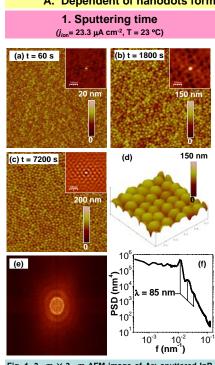


Fig. 1. 3 μm × 3 μm AFM image of Ar+ sputtered InP Fig. 1.5 μ m × 5 μ m × 6 μ m × 1 μ m range of × 5 μ m × 60 s, and (c) t = 7200 s. (d) 500 nm × 500 nm 3D AFM topography from a magnified area of (c). Insets are the self-correlated image calculated from the 1 μ m × 1 μ m magnified area of the corresponding AFM image. (e) Fourier Transform spectrum (FFT) and (f) angular average PSD function calculated from (c).

Ordering of the nanodots array increases with the increasing of sputtering duration.

> After 7200s of sputtering, a hexagonal nanodots array is formed, Fig. 1(C):

- Coherence length > 500 nm
- Mean inter-dot distance = 85 nm
- Dot diameter = 73 ± 10 nm
- Dot density = 1.3 × 10¹² dots/cm²

After 7200 s sputtering, the ordering of the nanodots does not improve, and is stable even after further sputtering.

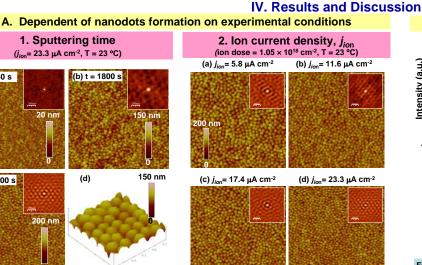


Fig. 2. 3 μm \times 3 μm AFM image of InP(100) surface sputtered by 1 keV Ar+ beam with different ion current density. Insets are the selfcorrelated image of 1 µm × 1 µm AFM image.

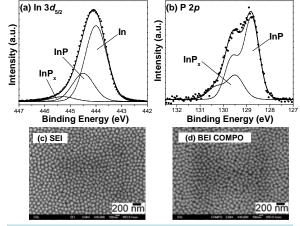
Ordering of the nanodots array increases with the increasing of ion current density (ion flux).

> A highly regular hexagonal pattern is formed at 23.3 µA cm⁻².

3. Temperature (j _{ion} = 23.3 μA cm ⁻² , ion dose = 1.05 × 10 ¹⁸ cm ⁻²)		
(a) T = -110 °C	(b) T = 23	°C
5 nm 500 nm × 500 nm 0	<mark>3 µm × 3</mark> µ	200 nm
(c) T = 36 °C	Temperature	RMS roughness (nm)
700 nm	Before sputtering	0.3
	-110 °C	0.5
	23 °C	17.4
5 μm × 5 μm	36 °C	76.8
o pin 20 o pin		

The dot diameter and height increase with the increasing of temperature

Well ordered hexagonal nanodots can only form at a specific temperature window.



B. SEM and in-situ XPS analysis

Fig. 4. (a) In 3d_{5/2} and (b) P 2p XPS spectra, (c) Secondary electron image (SEI) and (d) Backscattered electron composition image (COMPO) of nanodots array formed under 23.3 µA cm⁻², 1 keV Ar+ beam sputtered for 7200 s

XPS

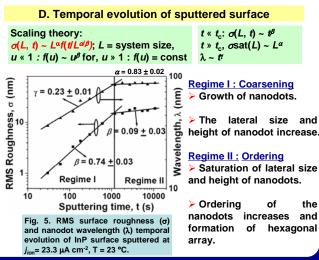
> Elemental In and InP, (x>1) are found on the sputtered surface

The ratio of In to P from the sputtered surface is 2.4.

SEM

The bright areas on COMPO image, Fig. 4(d), are due to the backscattered electron by In atoms.

Excess In atoms exist on the sputtered surface due to the preferential sputtering of P atoms.



VI. References

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V. Conclusions

Ordering of the nanodots formed under Ar* sputtering of InP(100) strongly dependent on experimental conditions such as temperature, ion flux, sputtering angle and sputtering duration.

The nanodots surface are In-rich due to the preferential sputtering of P atoms.

Using scaling theory, the evolution of the sputtered surface can be fitted into two different regimes: coarsening in the early-time regime and ordering in the late-time regime.